© Copyright 2005. IP	Convright 2005 IPC Bannockhurn Illinois All rights reserved under both				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
	-21.1 IPC Web Site for Information on IPC-1752 Standard For http://www.ipc.org/IPC-175x Dis				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials					ials and N	s and Mfg Information			
Supplier Information														
Company name* Con			Company unique ID			Unique ID Authority				Respor	Response Date*			
onsemi										2024-0	2024-05-18			
ntact Name Title - Contact			ct	]		Phone - Contact*				Email ·	Email - Contact*			
Product-Env-Stewards Product			roduct Enviro Compliance			NA				Produ	Product-Env-Stewards@onsemi.com			
Authorized Representative* Title - Rep			Representative			Phone - Representative*				Email ·	Email - Representative*			
Product-Env-Stewards	Product Envi	Product Enviro Compliance			NA				Produ	Product-Env-Stewards@onsemi.com				
Requester Item Number	Mfr Iten	n Number	Mfr Item Name			Effective Date	Version	М	Manufacturing Site		Weight*	UOM	Unit Type	
	NTMJS WG	TMJS1D2N04CLT T6 40V LL LF /G		PAK		2024-05-18		Pl	РВВ		99.445	mg	Each	
Manufacturing Proccess Informat	on													
Terminal Plating / Grid Array Mat	erial	al Terminal Base Alloy		-STD-020 MSL Rating		Peak Process Body Temperat		emperature	ure Max Time at Peak Temper		ture Num	ber of Reflow Cyd	les	
Matte Tin (Sn) - annealed CU Allo		CU Alloy	1			260		С	30	seco	nds 3			
Comments														
level 1 - maximum time at peak temperatu	e during so	ldering is 10-3	0 seconds											
For more information regarding material c	omposition	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).										
cadmium, hexavalentchromium, polybromina contains a RoHS restricted substance inexces encompass all such components. Supplier cer as of the date that Supplier completes this for Company acknowledges that Supplier may h independently verified information provided certification in this paragraph. If the Company that agreement, will be the sole and exclusive	lease indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, admium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part ontains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall ncompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, s of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. 'ompany acknowledges that Supplier may have relied on informationprovided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not idependently verified information provided by others, Supplier agrees that, at a minimum, itsuppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the ertification in the sole and exclusivesource of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the 'arranty' rights and/or remedies of Supplier's Standard Terms andConditions of Sale applicable to such part shall apply.										
RoHS Declaration * 4 - Item(	s) does not contain RoHS restricted subst	ances per the definition above except for sele	ected exempt	ions Supplier Acceptance	* Accepted						
Exemption: 7a: Lead in high melting temp	erature type solders (i.e. lead based sol	der alloys containing 85% by weight or m	ore lead).								
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.											
Supplier Digital Signature	astislav Drska	Le									

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Clip	6.9	mg	Supplier	Iron (Fe)	7439-89-6		0.0083	mg
			Supplier	Copper (Cu)	7440-50-8		6.8896	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0021	mg
Die	1.1	mg	Supplier	Silicon (Si)	7440-21-3		1.1	mg
Lead Frame	36.7	mg	Supplier	Silver (Ag)	7440-22-4		0.0037	mg
			Supplier	Iron (Fe)	7439-89-6		0.044	mg
			Supplier	Copper (Cu)	7440-50-8		36.6413	mg
			Supplier	Phosphorus (P)	7723-14-0		0.011	mg
Mold Compound-Black	41.4	mg	Supplier	Trimethoxysilylpropanethiol	4420-74-0		0.207	mg
			Supplier	Boron zinc hydroxide oxide	138265-88-0		6.21	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		6.21	mg
			Supplier	Carbon Black (C)	1333-86-4		0.1035	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		26.3925	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		2.277	mg
lating	6.3	mg	Supplier	Tin (Sn)	7440-31-5		6.3	mg
Solder Paste	7.0	mg	Supplier	Silver (Ag)	7440-22-4		0.175	mg
			А	Lead (Pb)	7439-92-1	7a	6.475	mg
			Supplier	Tin (Sn)	7440-31-5		0.35	mg
Wire Bond - Cu	0.045	mg	Supplier	Copper (Cu)	7440-50-8		0.045	mg